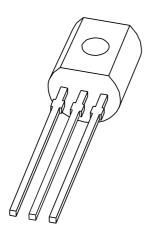
DISCRETE SEMICONDUCTORS

DATA SHEET



2N3906 PNP switching transistor

Product specification Supersedes data of 1999 Apr 23 2004 Oct 11





PNP switching transistor

2N3906

FEATURES

- Low current (max. 200 mA)
- Low voltage (max. 40 V).

APPLICATIONS

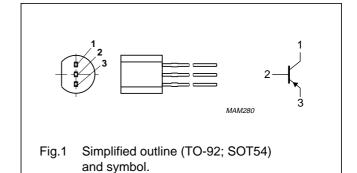
• High-speed switching in industrial applications.

DESCRIPTION

PNP switching transistor in a TO-92; SOT54 plastic package. NPN complement: 2N3904.

PINNING

PIN	DESCRIPTION
1	collector
2	base
3	emitter



ORDERING INFORMATION

TYPE NUMBER		PACKAGE					
ITPE NOWIBER	NAME	DESCRIPTION	VERSION				
2N3906	SC-43A	plastic single-ended leaded (through hole) package; 3 leads S					

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	PARAMETER CONDITIONS		MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-40	V
V _{CEO}	collector-emitter voltage	open base	_	-40	V
V _{EBO}	emitter-base voltage	open collector	_	-6	V
I _C	collector current (DC)		_	-200	mA
I _{CM}	peak collector current		_	-300	mA
I _{BM}	peak base current		_	-100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	_	500	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	ambient temperature		-65	+150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	250	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -30 \text{ V}; I_{E} = 0 \text{ A}$	_	-50	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -6 \text{ V}; I_C = 0 \text{ A}$	_	-50	nA
h _{FE}	DC current gain	$V_{CE} = -1 \text{ V}$; note 1; see Fig.2			
		$I_{\rm C} = -0.1 \text{mA}$	60	-	
		$I_C = -1 \text{ mA}$	80	-	
		$I_{\rm C} = -10 \text{mA}$	100	300	
		$I_{\rm C} = -50 \text{mA}$	60	_	
		$I_C = -100 \text{ mA}$	30	-	
V _{CEsat}	collector-emitter saturation	$I_C = -10 \text{ mA}$; $I_B = -1 \text{ mA}$; note 1	_	-200	mV
	voltage	$I_C = -50 \text{ mA}$; $I_B = -5 \text{ mA}$; note 1	_	-200	mV
V _{BEsat}	base-emitter saturation voltage	$I_C = -10 \text{ mA}$; $I_B = -1 \text{ mA}$; note 1	_	-850	mV
		$I_C = -50 \text{ mA}$; $I_B = -5 \text{ mA}$; note 1	_	-950	mV
C _c	collector capacitance	$V_{CB} = -5 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	_	4.5	pF
C _e	emitter capacitance	$I_C = i_c = 0$; $V_{EB} = -500 \text{ mV}$; $f = 1 \text{ MHz}$	_	10	pF
f _T	transition frequency	$V_{CE} = -20 \text{ V}; I_{C} = -10 \text{ mA}; f = 100 \text{ MHz}$	250	_	MHz
F	noise figure	$V_{CE} = -5 \text{ V}; I_C = -100 \text{ μA}; R_S = 1 \text{ k}\Omega;$ f = 10 Hz to 15.7 kHz	-	4	dB
Switching t	imes (between 10 % and 90 % lev	rels); see Fig.3	•	•	
t _{on}	turn-on time	$I_{Con} = -10 \text{ mA}; I_{Bon} = -1 \text{ mA};$	_	65	ns
t _d	delay time	I _{Boff} = 1 mA	_	35	ns
t _r	rise time	1	_	35	ns
t _{off}	turn-off time	1	_	300	ns
t _s	storage time	1	_	225	ns
t _f	fall time	1	_	75	ns

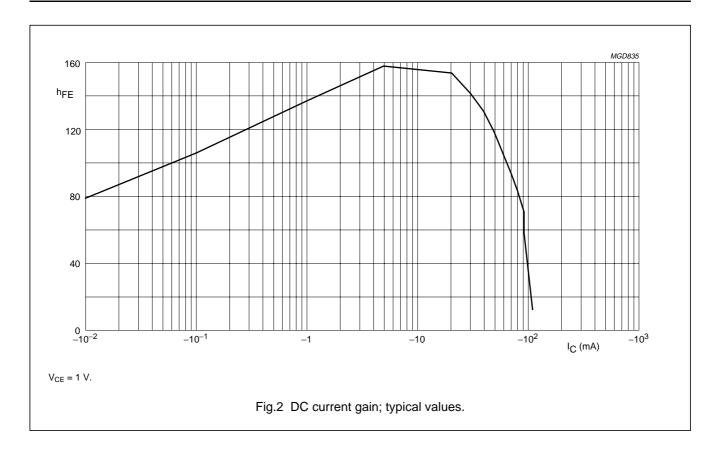
Note

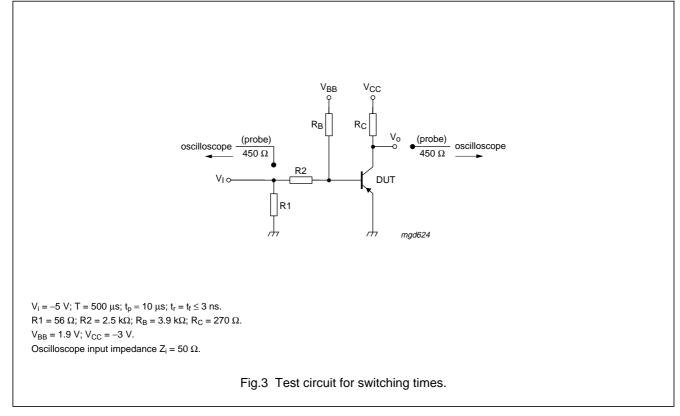
1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

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PNP switching transistor

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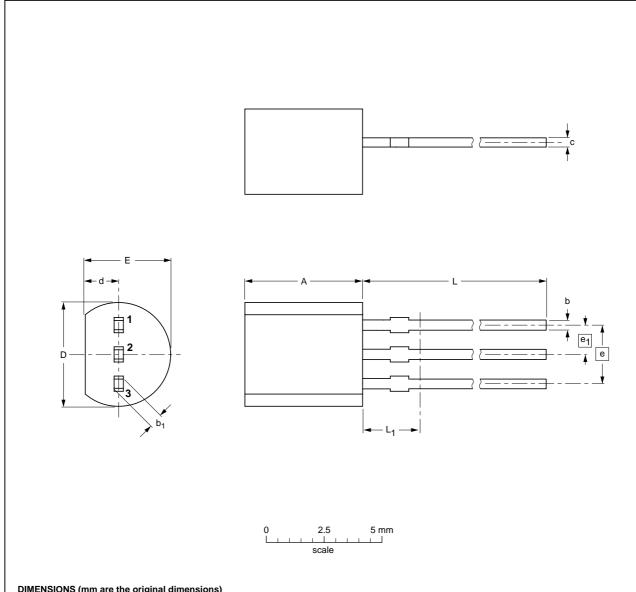
PNP switching transistor

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PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



DIMENSIONS (mm are the original dimensions)

UNIT	A	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.	
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5	

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
SOT54		TO-92	SC-43A			97-02-28 04-06-28

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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